

International IOR Rectifier

80EBU04

Ultrafast Soft Recovery Diode

Features

- Ultrafast Recovery
- 175°C Operating Junction Temperature
- Screw Mounting Only
- Lead-Free Plating

Benefits

- Reduced RFI and EMI
- Higher Frequency Operation
- Reduced Snubbing
- Reduced Parts Count

Description/ Applications

These diodes are optimized to reduce losses and EMI/ RFI in high frequency power conditioning systems. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for HF welding, power converters and other applications where switching losses are not significant portion of the total losses.

$$t_{rr} = 50\text{ns (typ)}$$

$$I_{F(AV)} = 80\text{Amp}$$

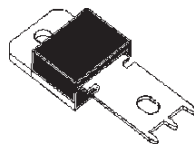
$$V_R = 400\text{V}$$

Absolute Maximum Ratings

	Parameters	Max	Units
V_R	Cathode to Anode Voltage	400	V
$I_{F(AV)}$	Continuous Forward Current, $T_C = 101^\circ\text{C}$	80	A
I_{FSM}	Single Pulse Forward Current, $T_C = 25^\circ\text{C}$	800	
I_{FRM} ①	Maximum Repetitive Forward Current	160	
T_J, T_{STG}	Operating Junction and Storage Temperatures	- 55 to 175	$^\circ\text{C}$

① Square Wave, 20kHz

Case Styles



Pow/RTab

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Parameters	Min	Typ	Max	Units	Test Conditions
V _{BR} , V _r Breakdown Voltage, Blocking Voltage	400	-	-	V	I _R = 100μA
V _F Forward Voltage	-	1.1	1.3	V	I _F = 80A
	-	0.92	1.08	V	I _F = 80A, T _J = 175°C
	-	0.98	1.15	V	I _F = 80A, T _J = 125°C
I _R Reverse Leakage Current	-	-	50	μA	V _R = V _R Rated
	-	-	2	mA	T _J = 150°C, V _R = V _R Rated
C _T Junction Capacitance	-	50	-	pF	V _R = 200V
L _S Series Inductance	-	3.5	-	nH	Measured lead to lead 5mm from package body

Dynamic Recovery Characteristics @ T_J = 25°C (unless otherwise specified)

Parameters	Min	Typ	Max	Units	Test Conditions	
t _{rr} Reverse Recovery Time	-	50	60	ns	I _F = 1A, di _F /dt = 200A/μs, V _R = 30V	
	-	87	-		T _J = 25°C	I _F = 80A V _R = 200V di _F /dt = 200A/μs
	-	151	-		T _J = 125°C	
I _{RRM} Peak Recovery Current	-	9.3	-	A	T _J = 25°C	
	-	17.2	-		T _J = 125°C	
Q _{rr} Reverse Recovery Charge	-	405	-	nC	T _J = 25°C	
	-	-	1300	-	T _J = 125°C	

Thermal - Mechanical Characteristics

Parameters	Min	Typ	Max	Units
R _{thJC} Thermal Resistance, Junction to Case			0.70	K/W
R _{thCS} ② Thermal Resistance, Case to Heatsink		0.2		
Wt Weight			5.02	g
			0.18	(oz)
T Mounting Torque	1.2		2.4	N * m
	10		20	lbf.in

② Mounting Surface, Flat, Smooth and Greased

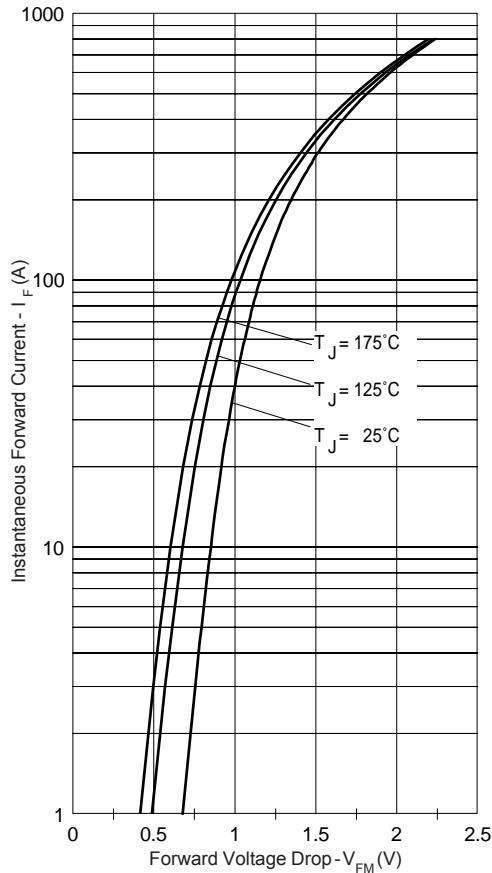


Fig. 1 - Typical Forward Voltage Drop Characteristics

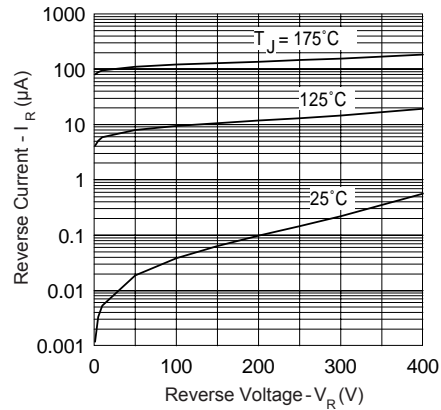


Fig. 2 - Typical Values Of Reverse Current Vs. Reverse Voltage

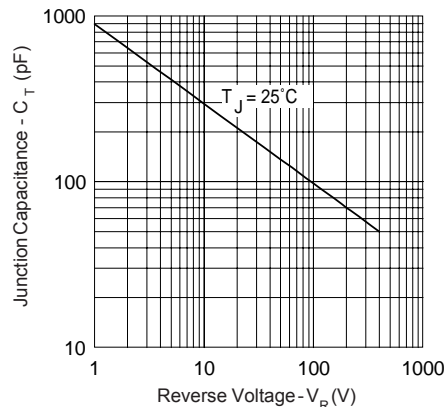


Fig. 3 - Typical Junction Capacitance Vs. Reverse Voltage

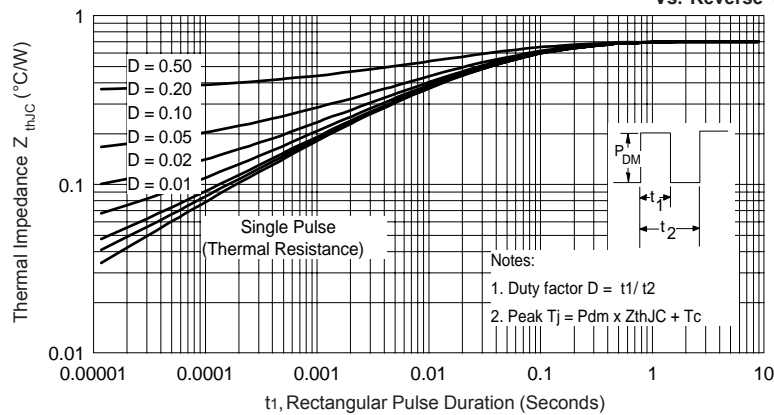


Fig. 4 - Max. Thermal Impedance Z_{thJC} Characteristics

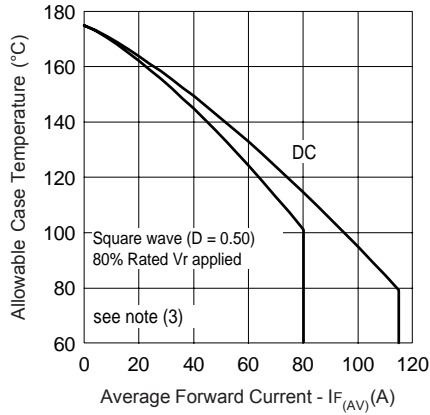


Fig. 5 - Max. Allowable Case Temperature Vs. Average Forward Current

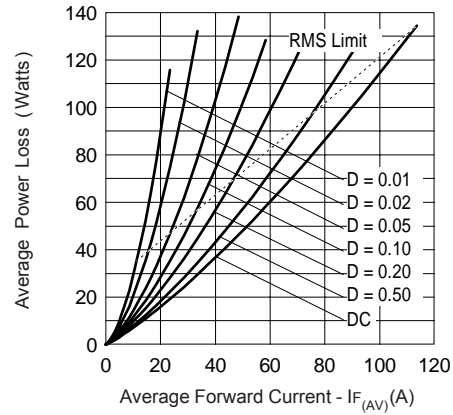


Fig. 6 - Forward Power Loss Characteristics

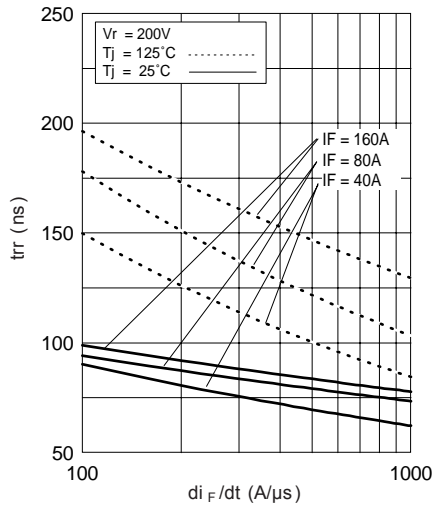


Fig. 7 - Typical Reverse Recovery time vs. di_F/dt

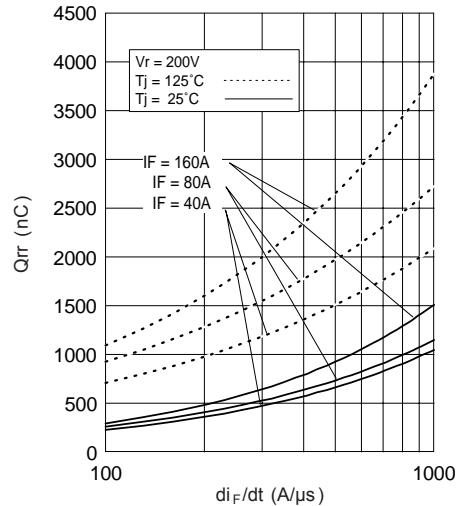
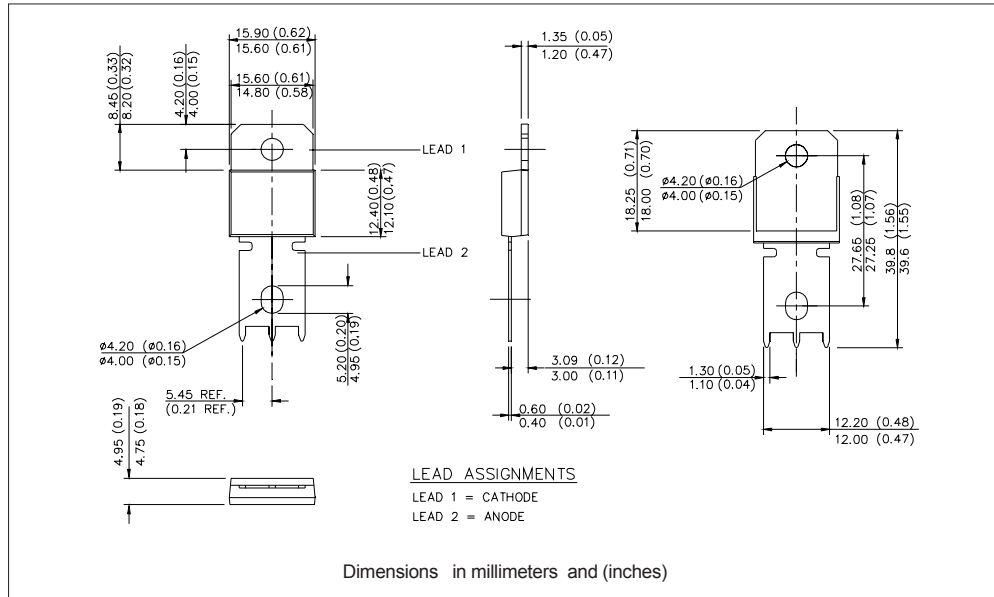


Fig. 8 - Typical Stored Charge vs. di_F/dt

(3) Formula used: $T_C = T_J - (P_d + P_{d_{REV}}) \times R_{thJC}$;
 $P_d = \text{Forward Power Loss} = I_{F(AV)} \times V_{FM} @ (I_{F(AV)} / D)$ (see Fig. 6);
 $P_{d_{REV}} = \text{Inverse Power Loss} = V_{R1} \times I_{R1} (1 - D)$; $I_{R1} @ V_{R1} = 80\% \text{ rated } V_R$

Outline Table



Ordering Information Table

Device Code				
80	E	B	U	04
①	②	③	④	⑤
1	- Current Rating		(80 = 80A)	
2	- Single Diode			
3	- Pow/IRtab		(Ultrafast/ Hyperfast only)	
4	- Ultrafast Recovery			
5	- Voltage Rating		(04 = 400V)	

Data and specifications subject to change without notice.
This product has been designed and qualified for Industrial Level and Lead-Free.
Qualification Standards can be found on IR's Web site.



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